

技术交底书

Technology Disclosure Form

<p>1. 技术领域 Technical Field</p>	<p>(请详细阐明该发明所要解决技术问题所属的技术领域) (Please summarize current problems in the technical field.)</p>
<p>2. 技术背景 Technical Background</p>	<p>(写明对发明的理解、检索、审查有用的背景技术, 有可能的, 并引证反映这些背景技术的文件) (Please list the most relevant publications and patents (of which you are aware) that closely relate to this invention.)</p>
<p>3. 发明内容 Description of Invention</p>	<p>(写明发明所要解决的技术问题以及为解决技术问题所采用的技术方案, 并对照现有技术写明发明的有益效果) (Please briefly describe the problem that the technology solves and its advantages/benefits relative to competing technologies.)</p>
<p>4. 发明附图 Illustration of the Drawings</p>	<p>(说明书有附图的, 对各附图作简略说明) (Please briefly illustrate the attached pictures, diagrams of apparatuses, chemical structures, and flow charts of processes.)</p>
<p>5. 实施例 Specific Embodiments</p>	<p>(详细写明申请人认为实现发明的优选方式; 必要时, 举例说明; 有附图的, 对照附图) (Please describe samples, prototype, working model, demo, etc.)</p>

地点 (Inventor's Address):

日期 (Date Signed):